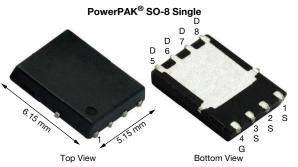
Si7850ADP

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Vishay Siliconix



PRODUCT SUMMARY	
V _{DS} (V)	60
$R_{DS(on)}$ max. (Ω) at V_{GS} = 10 V	0.0195
$R_{DS(on)}$ max. (Ω) at V_{GS} = 4.5 V	0.0250
Q _g typ. (nC)	5.2
I _D (A)	12 ^{a, g}
Configuration	Single

FEATURES

N-Channel 60 V (D-S) MOSFET

- TrenchFET[®] Gen IV power MOSFET
- 100 % R_g and UIS tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- Synchronous rectification
- Primary side switch
- DC/DC converters
- Power supplies
- Motor drive control
- · Battery and load switch



ORDERING	INFORMATION
Package	

ĺ	Package	PowerPAK SO-8
ĺ	Lead (Pb)-free and halogen-free	Si7850ADP-T1-GE3

PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V _{DS}	60		
Gate-source voltage		V _{GS}	± 20	V	
	T _C = 25 °C		12 ^a		
Constitution of the comment (T 150 °C)	T _C = 70 °C		12 ^a		
Continuous drain current (T _J = 150 °C)	T _A = 25 °C		10.3 ^{b, c}		
	T _A = 70 °C	1 –	8.1 ^{b, c}	•	
Pulsed drain current (t = 100 µs)			40	— A	
	T _C = 25 °C		12 ^a		
Continuous source-drain diode current	T _A = 25 °C	I _S	3 b, c		
Single pulse avalanche current		I _{AS}	15		
$L = 0.1 \text{ mH} \qquad \qquad IAS \qquad \qquad IS \qquad IS \qquad \qquad IS \qquad IS \qquad IS \qquad \qquad IS \qquad \qquad IS \qquad IS \qquad \qquad IS \qquad IS \qquad \qquad IS \qquad \qquad IS \qquad \qquad IS \qquad I$		11.3	mJ		
	T _C = 25 °C		35.7		
Maniana a successible distanti	T _C = 70 °C		22.9	w	
Maximum power dissipation	mum power dissipation $T_A = 25 \degree C$ P_D	3.6 ^{b, c}	VV		
	T _A = 70 °C	1 –	2.3 ^{b, c}		
Operating junction and storage temperature	e range	T _J , T _{stg}	-55 to +150	<u> </u>	
Soldering recommendations (peak temperature) c			260		

THERMAL RESISTANCE RATING	GS				
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT
Maximum junction-to-ambient ^b	t ≤ 10 s	R _{thJA}	25	35	°C/W
Maximum junction-to-case (drain)	Steady state	R _{thJC}	2.7	3.5	0/10

Notes

a. Package limited

b. Surface mounted on 1" x 1" FR4 board

c. t = 10 s

d. See solder profile (www.vishay.com/doc?73257). The PowerPAK SO-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection

e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components

Maximum under steady state conditions is 70 °C/W f.

T_C = 25 °C g.

S17-1506-Rev. A, 02-Oct-17

1

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PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static					•	•
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 V, I_D = 250 \mu A$	60	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	1 2504	-	33	-	
V _{GS(th)} temperature coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA	-	-4.8	-	mV/°C
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	1	-	2.8	V
Gate-source leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$	-	-	100	nA
Zere gete veltege drein eurrent		$V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}$	-	-	1	
Zero gate voltage drain current	IDSS	$V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 70 ^{\circ}\text{C}$	-	-	10	μA
On-state drain current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	10	-	-	Α
		V _{GS} =10 V, I _D = 10 A	-	0.0160	0.0195	Ω
Drain-source on-state resistance ^a	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 5 \text{ A}$	-	0.0200	0.0250	
Forward transconductance ^a	g _{fs}	V _{DS} = 10 V, I _D = 10 A	-	39	-	S
Dynamic ^b			•	•		
Input capacitance	C _{iss}		-	790	-	
Output capacitance	C _{oss}	$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ f} = 1 \text{ MHz}$	-	330	-	pF
Reverse transfer capacitance	C _{rss}		-	14	-	
Talala ale ale an	0	$V_{DS} = 30 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 5 \text{ A}$	-	11.1	17	
Total gate charge	Qg	V _{DS} = 30 V, V _{GS} = 4.5 V, I _D = 5 A	-	5.2	8	
Gate-source charge	Q _{gs}		-	2.2	-	nC
Gate-drain charge	Q _{gd}		-	1.1	-	
Gate resistance	R _q	f = 1 MHz	0.1	0.6	1.2	Ω
Turn-on delay time	t _{d(on)}		-	7	15	
Rise time	t _r	$V_{DD} = 30 \text{ V}, \text{ R}_{L} = 6 \Omega, \text{ I}_{D} \cong 5 \text{ A},$	-	21	40	
Turn-off delay time	t _{d(off)}	$V_{\text{GEN}} = 10 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$	-	10	20	-
Fall time	t _f		-	10	20	
Turn-on delay time	t _{d(on)}		-	13	25	ns
Rise time	t _r	$V_{DD} = 30 \text{ V}, \text{ R}_1 = 6 \Omega, \text{ I}_D \cong 5 \text{ A},$	-	25	50	
Turn-off delay time	t _{d(off)}	$V_{\text{GEN}} = 4.5 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$	-	10	20	
Fall time	t _f		-	22	45	
Drain-Source Body Diode Characteristi	cs				1	
Continuous source-drain diode current	Is	T _C = 25 °C	-	-	12	
Pulse diode forward current	I _{SM}	-	-	-	40	A
Body diode voltage	V _{SD}	I _S = 5 A, V _{GS} = 0 V	-	0.79	1.2	V
Body diode reverse recovery time	t _{rr}		-	30	60	ns
Body diode reverse recovery charge	Q _{rr}		-	60	120	nC
Reverse recovery fall time	ta	$I_F = 5 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^\circ\text{C}$	-	15	-	
Reverse recovery rise time	t _b		_	15	_	ns

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %

b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

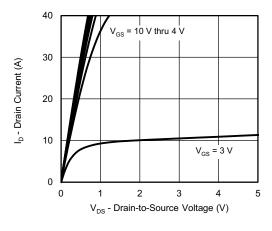
2



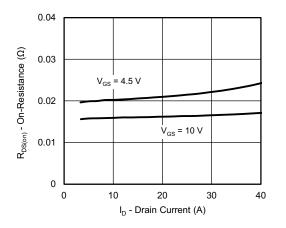
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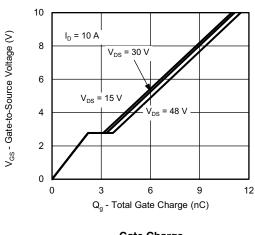
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



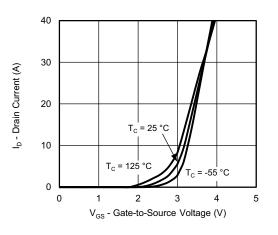
Output Characteristics



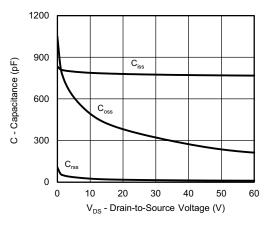
On-Resistance vs. Drain Current and Gate Voltage



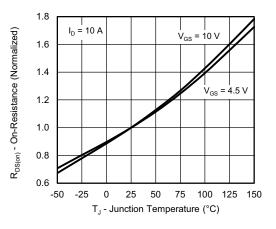
Gate Charge



Transfer Characteristics



Capacitance



On-Resistance vs. Junction Temperature

3

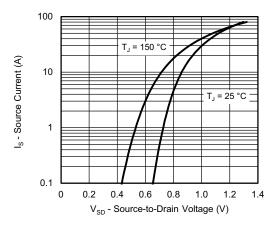
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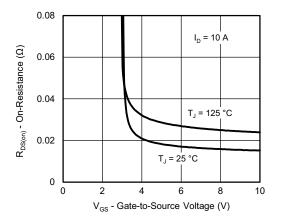


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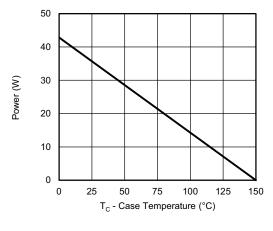
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



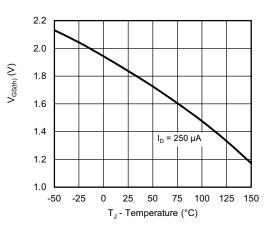
Source-Drain Diode Forward Voltage



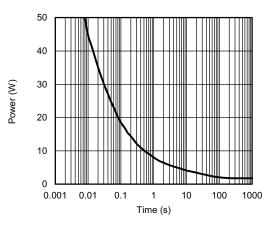
On-Resistance vs. Gate-to-Source Voltage



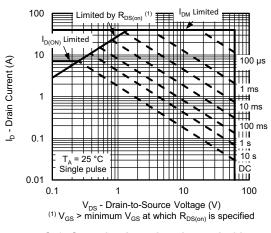
Power, Junction-to-Case



Threshold Voltage



Single Pulse Power, Junction-to-Ambient



Safe Operating Area, Junction-to-Ambient

S17-1506-Rev. A, 02-Oct-17

4

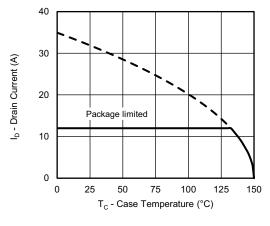
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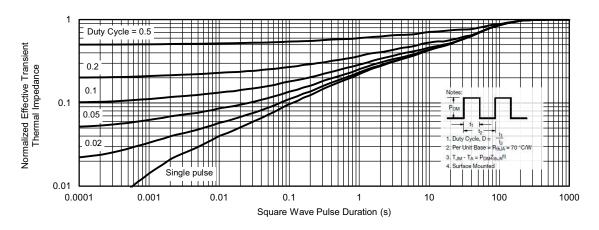
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



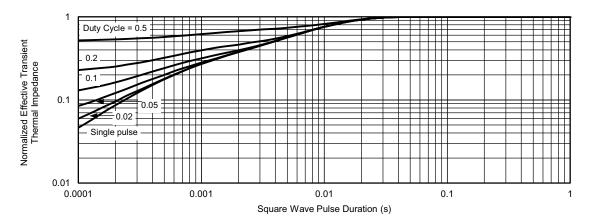
Current Derating ^a

Note

a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit



Normalized Thermal Transient Impedance, Junction-to-Ambient





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S17-1506-Rev. A, 02-Oct-17	5
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D2

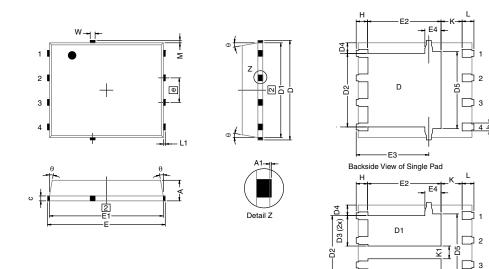
E3

Backside View of Dual Pad



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PowerPAK[®] SO-8, (Single/Dual)



Notes

1. Inch will govern.

2 Dimensions exclusive of mold gate burrs.

3. Dimensions exclusive of mold flash and cutting burrs.

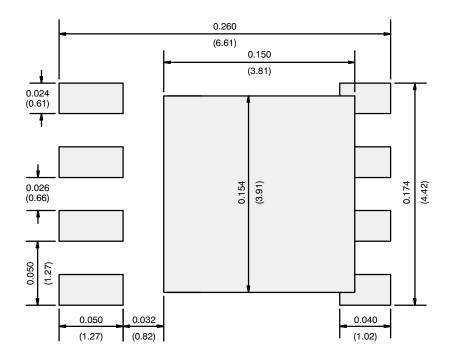
D 114		MILLIMETERS		INCHES			
DIM.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX	
А	0.97	1.04	1.12	0.038	0.041	0.044	
A1		-	0.05	0	-	0.002	
b	0.33	0.41	0.51	0.013	0.016	0.020	
С	0.23	0.28	0.33	0.009	0.011	0.013	
D	5.05	5.15	5.26	0.199	0.203	0.207	
D1	4.80	4.90	5.00	0.189	0.193	0.197	
D2	3.56	3.76	3.91	0.140	0.148	0.154	
D3	1.32	1.50	1.68	0.052	0.059	0.066	
D4		0.57 typ.			0.0225 typ.		
D5		3.98 typ.			0.157 typ.		
E	6.05	6.15	6.25	0.238	0.242	0.246	
E1	5.79	5.89	5.99	0.228	0.232	0.236	
E2	3.48	3.66	3.84	0.137	0.144	0.151	
E3	3.68	3.78	3.91	0.145	0.149	0.154	
E4		0.75 typ.			0.030 typ.		
е		1.27 BSC			0.050 BSC		
К		1.27 typ.			0.050 typ.		
K1	0.56	-	-	0.022	-	-	
Н	0.51	0.61	0.71	0.020	0.024	0.028	
L	0.51	0.61	0.71	0.020	0.024	0.028	
L1	0.06	0.13	0.20	0.002	0.005	0.008	
θ	0°	-	12°	0°	-	12°	
W	0.15	0.25	0.36	0.006	0.010	0.014	
М	0.125 typ. 0.005 typ.						



Application Note 826

Vishay Siliconix

RECOMMENDED MINIMUM PADS FOR PowerPAK® SO-8 Single



Recommended Minimum Pads Dimensions in Inches/(mm)

Return to Index



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